

STL70N4LLF5

Automotive-grade N-channel 40 V, 6.1 mΩ typ., 18 A STripFET™ F5 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

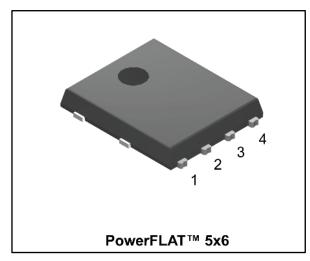
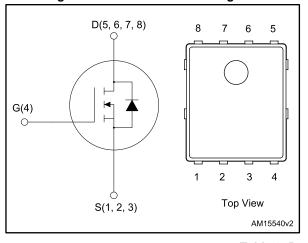


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max. | ID |
|-------------|-----------------|--------------------------|------|
| STL70N4LLF5 | 40 V | 6.7 mΩ | 18 A |



- AEC-Q101 qualified
- Low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power loss
- Wettable flank package

Applications

• Switching applications

Description

This N-channel Power MOSFET is developed using the STripFET[™] F5 technology and has been optimized to achieve very low on-state resistance, contributing to a FoM that is among the best in its class.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|-------------|----------|----------------|---------------|
| STL70N4LLF5 | 70N4LLF5 | PowerFLAT™ 5x6 | Tape and reel |

Contents STL70N4LLF5

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STL70N4LLF5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit | |
|-----------------------------------|--|------------|------|--|
| V _{DS} | Drain-source voltage | 40 | V | |
| V_{GS} | Gate-source voltage | ± 22 | V | |
| I _D ⁽¹⁾ | Drain current (continuous) at T _C = 25 °C | 70 | | |
| I _D ⁽¹⁾ | Drain current (continuous) at T _c = 100 °C | 44 | | |
| I _D ⁽²⁾ | Drain current (continuous) at T _{pcb} = 25 °C 18 | | | |
| I _D ⁽²⁾ | Drain current (continuous) at T _{pcb} = 100 °C 11.5 | | | |
| I _{DM} ⁽¹⁾⁽³⁾ | Drain current (pulsed) | 72 | | |
| P _{TOT} ⁽¹⁾ | Total dissipation at T _C = 25 °C | 72 | W | |
| P _{TOT} ⁽²⁾ | Total dissipation at T _{pcb} = 25 °C | 4.8 | VV | |
| T _{stg} | Storage temperature range | | | |
| TJ | Operation junction temperature range | -55 to 175 | °C | |

Notes:

Table 3: Thermal data

| Symbol | Parameter | Value | Unit | |
|-------------------------------------|--------------------------------------|-------|--------|--|
| R _{thj-case} | Thermal resistance junction-case 2.0 | | °CAM | |
| R _{thj-pcb} ⁽¹⁾ | Thermal resistance junction-pcb | 31.3 | - °C/W | |

Notes:

Table 4: Avalanche data

| Symbol | Parameter | | Unit |
|-----------------|--|-----|------|
| l _{AV} | Not-repetitive avalanche current (pulse width limited by T _{jmax.}) | 9 | Α |
| Eas | Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$, $V_{DD} = 24$ V) | 470 | mJ |

 $^{^{(1)} \}mbox{The value}$ is rated according to $R_{\mbox{\scriptsize thj-c}}.$

 $[\]ensuremath{^{(2)}} The value is rated according to <math display="inline">R_{thj\text{-pcb.}}$

⁽³⁾Pulse width limited by safe operating area

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s

Electrical characteristics STL70N4LLF5

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5: On/off-states

| Symbol | Parameter | Parameter Test conditions | | Тур. | Max. | Unit |
|---------------------|---------------------------------|---|----|------|------|------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | I _D = 250 μA, V _{GS} = 0 V | 40 | | | V |
| IDSS | Zero gate voltage drain current | $V_{GS} = 0 V$ $V_{DS} = 40 V$ | | | 1 | |
| IDSS | Zero gate voltage drain current | $V_{GS} = 0 \text{ V}$ $V_{DS} = 40 \text{ V}, T_J = 125 \text{ °C }^{(1)}$ | | | 10 | μА |
| Igss | Gate-body leakage current | V _{GS} = ± 22 V, V _{DS} = 0 V | | | ±100 | nA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | 1 | | 2.5 | V |
| D | Static drain-source | V _G S = 10 V, I _D = 9 A | | 6.1 | 6.7 | m0 |
| R _{DS(on)} | on-resistance | V _{GS} = 4.5 V, I _D = 9 A | | 7.6 | 9.0 | mΩ |

Notes:

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|------------------|------------------------------|---|------|------|------|------|
| C _{iss} | Input capacitance | | - | 1570 | - | pF |
| Coss | Output capacitance | V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V | | 257 | - | pF |
| Crss | Reverse transfer capacitance | | | 32 | - | pF |
| Qg | Total gate charge | V _{DD} = 15 V, I _D = 18 A, | ı | 12.9 | ı | nC |
| Qgs | Gate-source charge | V _G S = 4.5 V | ı | 3.9 | ı | nC |
| Q_{gd} | Gate-drain charge | (see Figure 14: "Test circuit for gate charge behavior") | 1 | 5.3 | 1 | nC |
| R _G | Gate input resistance | f = 1 MHz, gate DC bias = 0 V, test signal level = 20 mV, I _D = 0 A | - | 1.5 | - | Ω |

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|---|------|------|------|------|
| t _{d(on)} | Turn-on delay time | V _{DD} = 15 V, I _D = 9 A, | 1 | 14 | ı | ns |
| tr | Rise time | $R_G = 4.7 \Omega$, $V_{GS} = 10 V$ | - | 42 | - | ns |
| t _{d(off)} | Turn-off delay time | (see Figure 13: "Test circuit for | - | 37 | - | ns |
| t _f | Fall time | resistive load switching times" | - | 5.2 | - | ns |

⁽¹⁾Defined by design, not subject to production test

Table 8: Source-drain diode

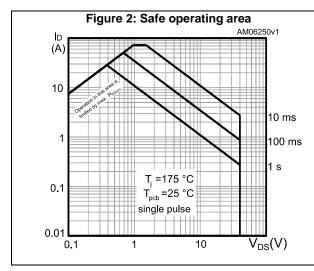
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|--|---|------|------|------|------|
| I _{SD} | Source-drain current | | - | | 18 | Α |
| I _{SDM} ⁽¹⁾ | Source-drain current pulsed | | - | | 72 | Α |
| V _{SD} ⁽²⁾ | Forward on voltage | I _{SD} = 18 A, V _{GS} = 0 V | | | 1.1 | ٧ |
| t _{rr} | Reverse recovery time | | - | 27.2 | | ns |
| Qrr | Reverse recovery charge $I_{SD} = 18 \text{ A}, \text{ di/dt} = 100 \text{ A/µs}, V_{DD} = 25 \text{ V}, T_J = 150 ^{\circ}\text{C}$ | | - | 24.5 | | nC |
| I _{RRM} | Reverse recovery current | 7 VDD - 20 V, 15 - 100 O | - | 1.8 | | Α |

Notes:

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

2.2 Electrical characteristics (curves)



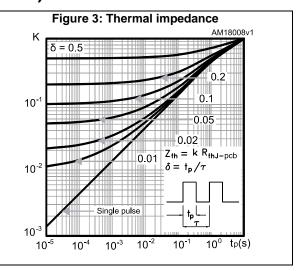


Figure 4: Output characteristics

ID

AM06251v1

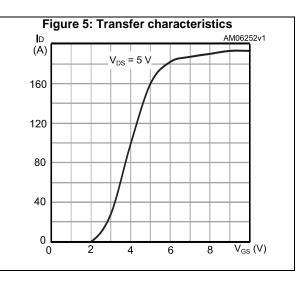
160

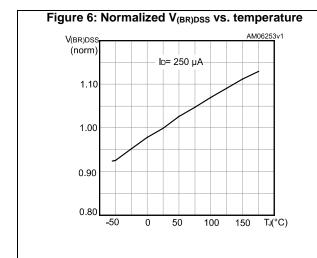
120

4 V

80

0 2 4 6 8 V_{DS}(V)





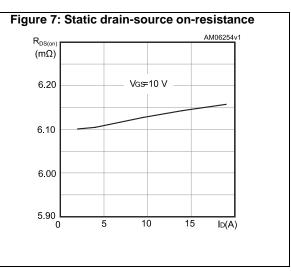


Figure 8: Gate charge vs. gate-source voltage

VGS
(V)
12
| VDD=15 V |
|D=18 A |
10
8
6
4
2
0
0 5 10 15 20 25 Qg(nC)

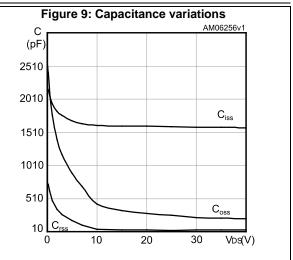
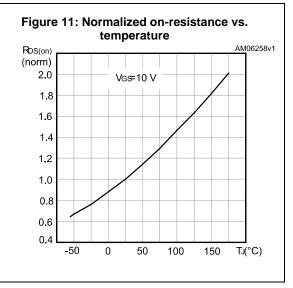
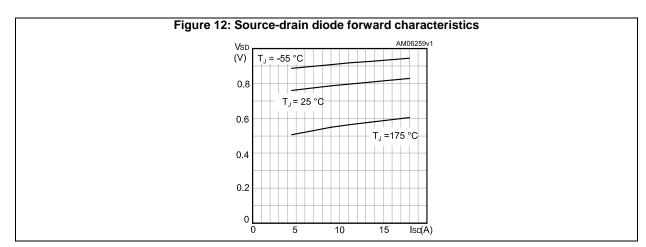


Figure 10: Normalized gate threshold voltage vs. temperature $V_{GS(th)}$ (norm) Vos=Vgs 1.2 lo= 250 μA 1.0 0.8 0.6 0.4 -50 0 50 100 150 TJ(°C)





Test circuits STL70N4LLF5

3 Test circuits

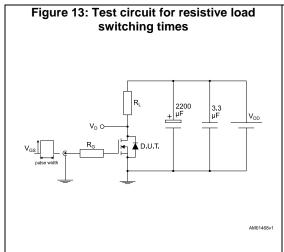
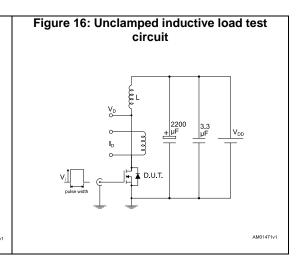
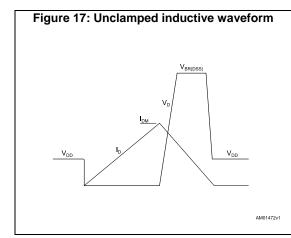


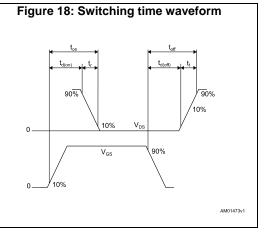
Figure 14: Test circuit for gate charge behavior

12 V 47 KQ 100 NF 1 KQ 100 N

Figure 15: Test circuit for inductive load switching and diode recovery times







5/

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 PowerFLAT™ 5x6 single island WF type C package information

Figure 19: PowerFLAT™ 5x6 WF type C package outline

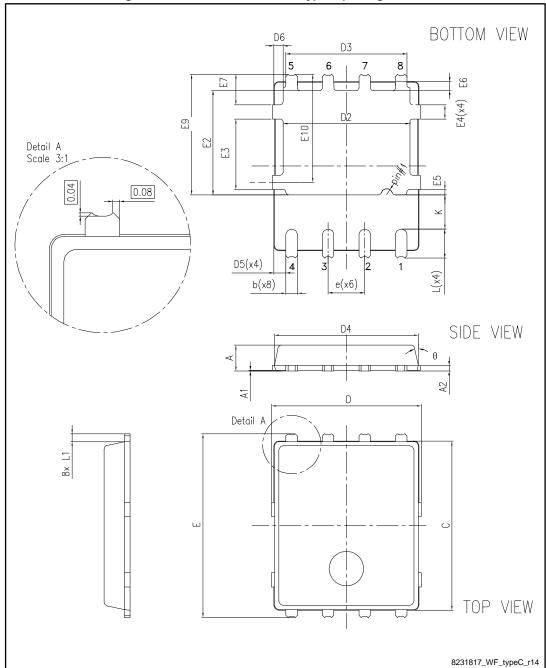
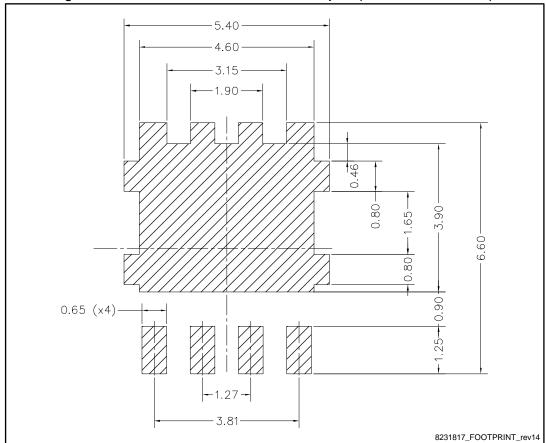


Table 9: PowerFLAT™ 5x6 WF type C mechanical data

| Di | | mm | |
|------|-------|-------|-------|
| Dim. | Min. | Тур. | Max. |
| А | 0.80 | | 1.00 |
| A1 | 0.02 | | 0.05 |
| A2 | | 0.25 | |
| b | 0.30 | | 0.50 |
| С | 5.80 | 6.00 | 6.10 |
| D | 5.00 | 5.20 | 5.40 |
| D2 | 4.15 | | 4.45 |
| D3 | 4.05 | 4.20 | 4.35 |
| D4 | 4.80 | 5.00 | 5.10 |
| D5 | 0.25 | 0.40 | 0.55 |
| D6 | 0.15 | 0.30 | 0.45 |
| е | | 1.27 | |
| Е | 6.20 | 6.40 | 6.60 |
| E2 | 3.50 | | 3.70 |
| E3 | 2.35 | | 2.55 |
| E4 | 0.40 | | 0.60 |
| E5 | 0.08 | | 0.28 |
| E6 | 0.20 | 0.325 | 0.45 |
| E7 | 0.85 | 1.00 | 1.15 |
| E9 | 4.00 | 4.20 | 4.40 |
| E10 | 3.55 | 3.70 | 3.85 |
| K | 1.05 | | 1.35 |
| L | 0.90 | 1.00 | 1.10 |
| L1 | 0.175 | 0.275 | 0.375 |
| θ | 0° | | 12° |





STL70N4LLF5 Package information

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

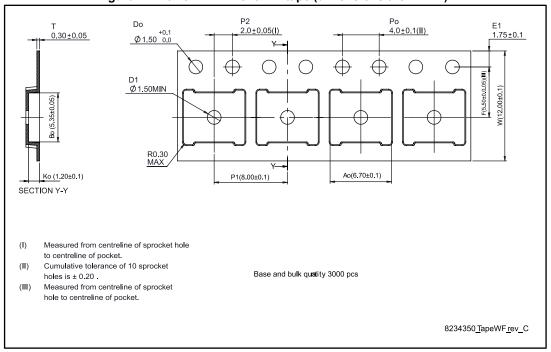
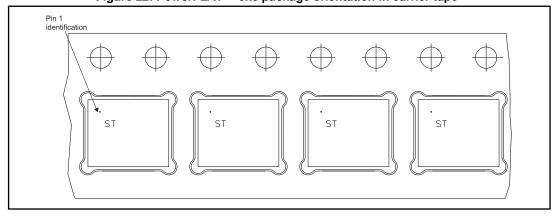


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



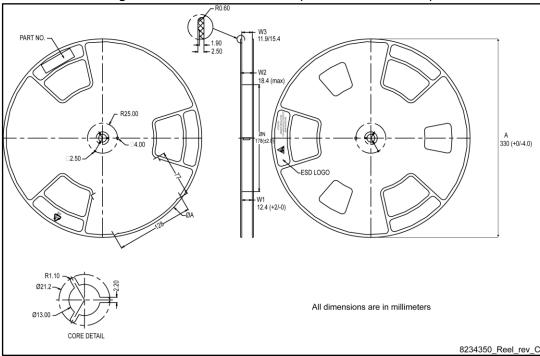


Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)

STL70N4LLF5 Revision history

5 Revision history

Table 10: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 01-Dec-2008 | 1 | First release. |
| 18-Jul-2011 | 2 | Section 4: Package mechanical data has been modified: - Added Table 9: PowerFLAT™ 5x6 type S-C mechanical data - Added Figure 19: PowerFLAT™ 5x6 type S-C mechanical data - Added PowerFLAT™ 5x6 type C-B mechanical data - Added PowerFLAT™ 5x6 type C-B drawing Minor text changes. |
| 21-Dec-2011 | 3 | Section 4: Package mechanical data has been modified. |
| 25-Jan-2013 | 4 | Table 1: Device summary has been updated. -Minor text changes. -Changed: Figure 1 -Added Section 5: Packaging mechanical data. |
| 12-Feb-2013 | 5 | -Updated T _J and T _{stg} in Table 2: Absolute maximum ratings. — Updated Section 4: Package mechanical data and Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape. |
| 24-May-2013 | 6 | - Modified: title and Section 4: Package mechanical data - Minor text changes. |
| 17-Dec-2014 | 7 | Modified: Figure 2 and 3 Updated: Figure 13, 14, 15 and 16 Updated: Section 4: Package mechanical data and Section 5: Packaging mechanical data Minor text changes. |
| 08-Apr-2016 | 8 | Updated Section 4: Package information and Section 4.1: Packing information Minor text changes. |
| 22-Sep-2016 | 9 | Updated V _{GS(th)} in <i>Table 5: "On/off-states"</i> . |

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